

Features

- $V_{ds} = 40V$, $I_d = 300A$
 $R_{DS(ON)}=0.95m\Omega$ (typ.) @ $V_{GS}=10V$
 $R_{DS(ON)}=1.5m\Omega$ (typ.) @ $V_{GS}=4.5V$
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- Wettable Flanks

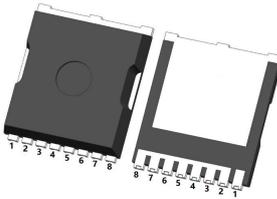
Application

- BLDC Motor driver
- SMPS 2nd Synchronous Rectifier
- DC-DC Converter

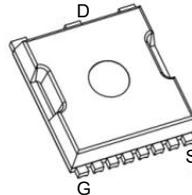


Package

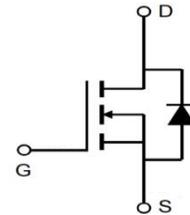
Top View



Top View



Schematic diagram



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
TF010N04TG	TF010N04TG	TOLL-8	-	-	-

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	$T_c=25^\circ C$	300
		$T_c=100^\circ C$	210
Pulsed Drain Current ¹	I_{DM}	960	A
Single Pulse Avalanche Energy ²	EAS	550	mJ
Total Power Dissipation	P_D	280	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$
Thermal Resistance from Junction-to-Ambient ³	$R_{\theta JA}$	35	$^\circ C/W$
Thermal Resistance from Junction-to-Case	$R_{\theta JC}$	0.9	$^\circ C/W$



Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	40	-	-	V
Gate-body Leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA
Zero Gate Voltage Drain Current	$T_J=25^\circ\text{C}$	I_{DSS} $V_{DS} = 36V, V_{GS} = 0V$	-	-	1	μA
	$T_J=100^\circ\text{C}$		-	-	100	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.6	2.5	V
Drain-Source on-Resistance ⁴	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 30A$	-	0.95	1.3	m Ω
		$V_{GS} = 4.5V, I_D = 20A$	-	1.50	2.3	
Dynamic Characteristics⁵						
Input Capacitance	C_{iss}	$V_{DS} = 20V, V_{GS} = 0V,$ $f = 1\text{MHz}$	-	7150	-	pF
Output Capacitance	C_{oss}		-	1750	-	
Reverse Transfer Capacitance	C_{rss}		-	202	-	
Gate Resistance	R_g	$f = 1\text{MHz}$	-	1.3	-	Ω
Switching Characteristics⁵						
Total Gate Charge	Q_g	$V_{GS} = 10V, V_{DS} = 20V,$ $I_D = 50A$	-	112.6	-	nC
Gate-Source Charge	Q_{gs}		-	22.8	-	
Gate-Drain Charge	Q_{gd}		-	17.5	-	
Turn-on Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 20V,$ $R_G = 3\Omega, I_D = 50A$	-	23.0	-	ns
Rise Time	t_r		-	15.1	-	
Turn-off Delay Time	$t_{d(off)}$		-	89.1	-	
Fall Time	t_f		-	29.0	-	
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 50A, di/dt = 100A/\mu s$	-	61.0	-	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	92.0	-	nC
Drain-Source Body Diode Characteristics						
Diode Forward Voltage ⁴	V_{SD}	$I_S = 30A, V_{GS} = 0V$	-	-	1.2	V
Continuous Source Current	$T_C=25^\circ\text{C}$	I_S	-	-	200	A

Notes:

1. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ\text{C}$.
2. The EAS data shows Max. rating . The test condition is $V_{DD} = 20V, V_{GS} = 10V, L = 0.5\text{mH}, I_{AS} = 30A$.
3. The data tested by surface mounted on a 1 inch2 FR-4 board with 20Z copper, The value in any given application depends on the user's specific board design.
4. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
5. This value is guaranteed by design hence it is not included in the production test.

Typical Characteristics

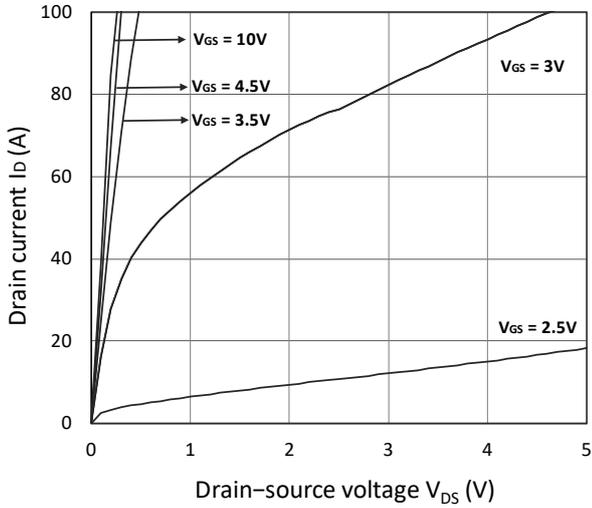


Figure 1. Output Characteristics

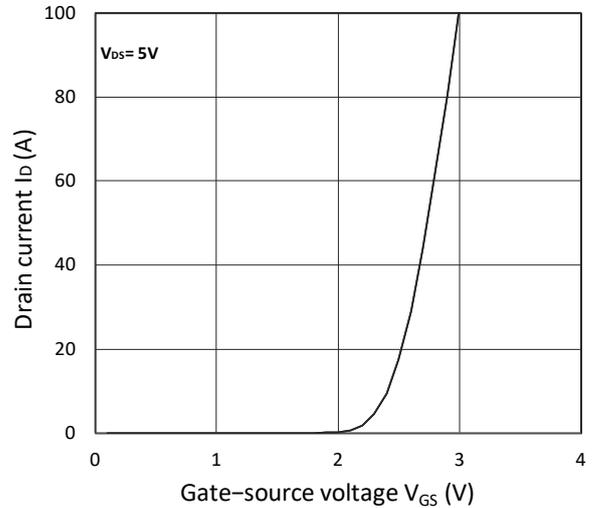


Figure 2. Transfer Characteristics

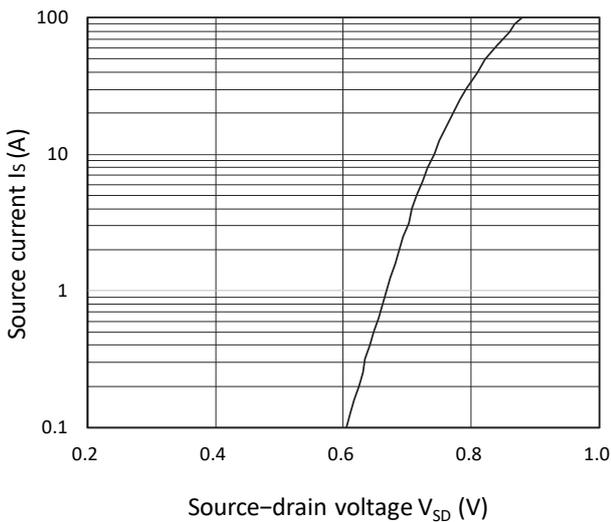


Figure 3. Forward Characteristics of Reverse

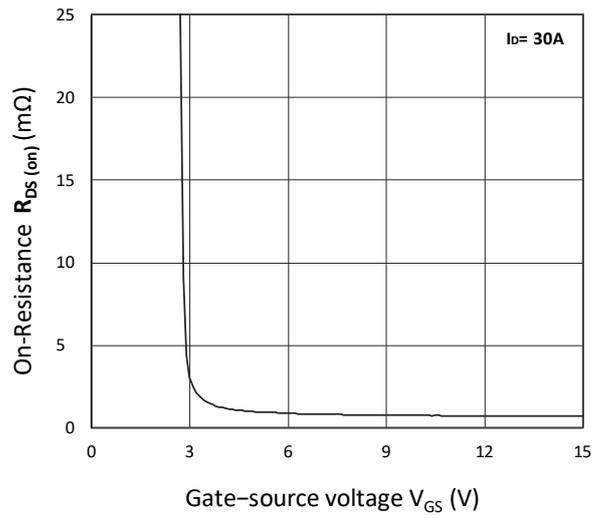


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

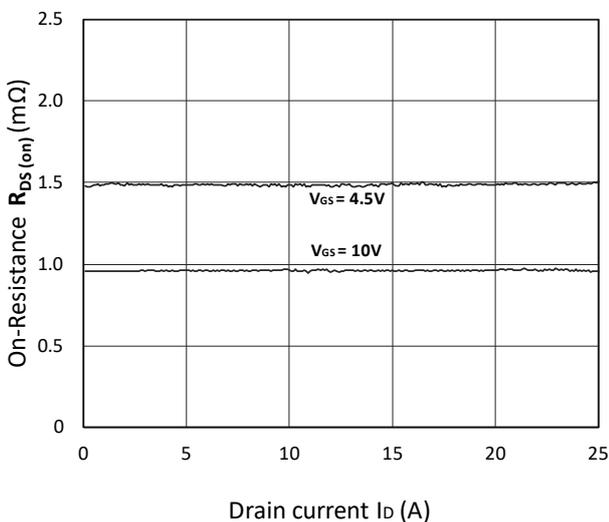


Figure 5. $R_{DS(ON)}$ vs. I_D

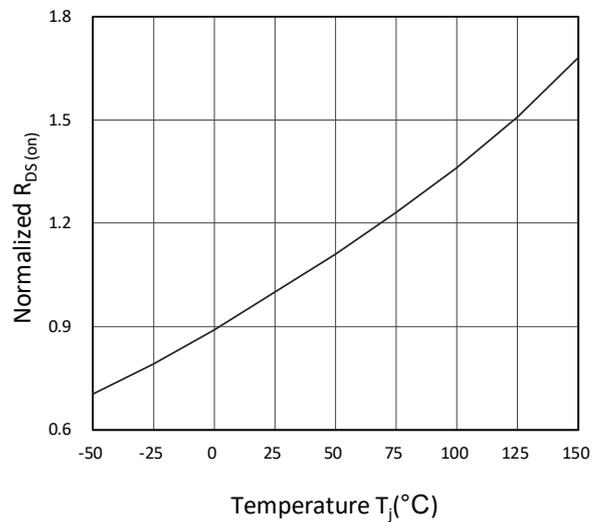


Figure 6. Normalized $R_{DS(ON)}$ vs. Temperature

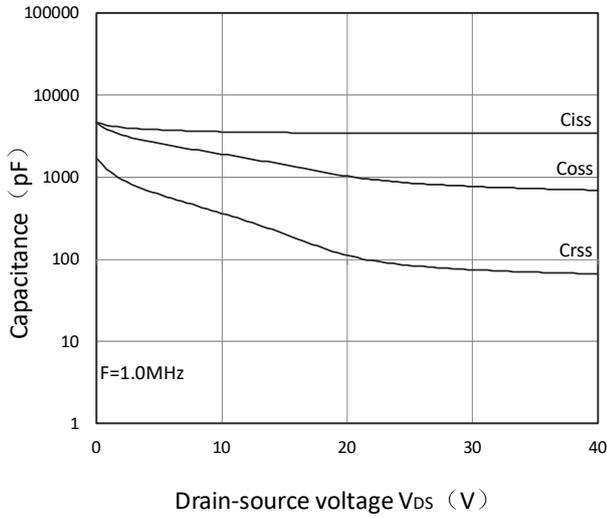


Figure 7. Capacitance Characteristics

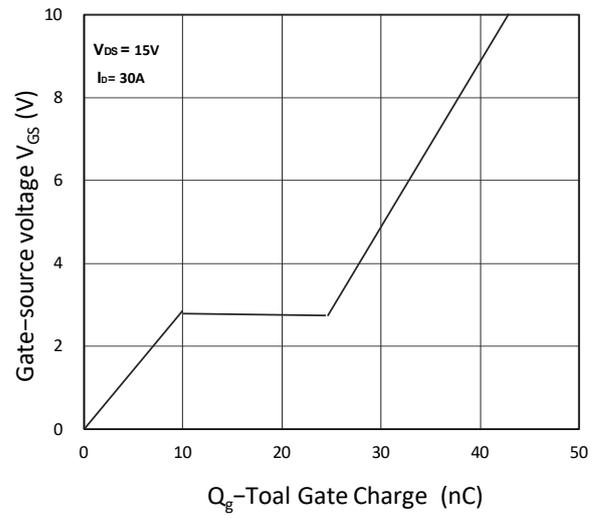


Figure 8. Gate Charge Characteristics

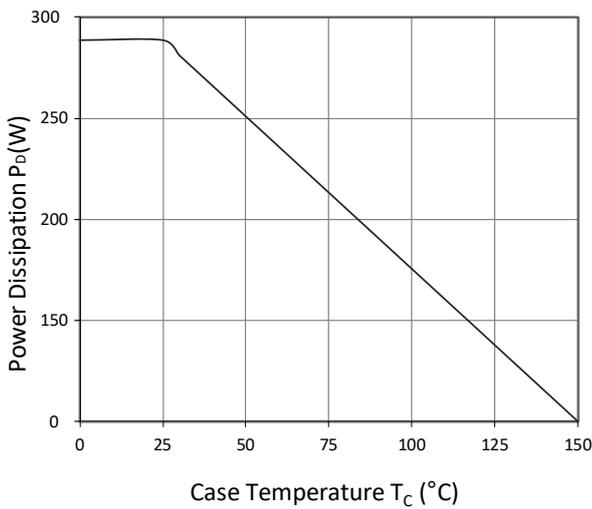


Figure 9. Power Dissipation

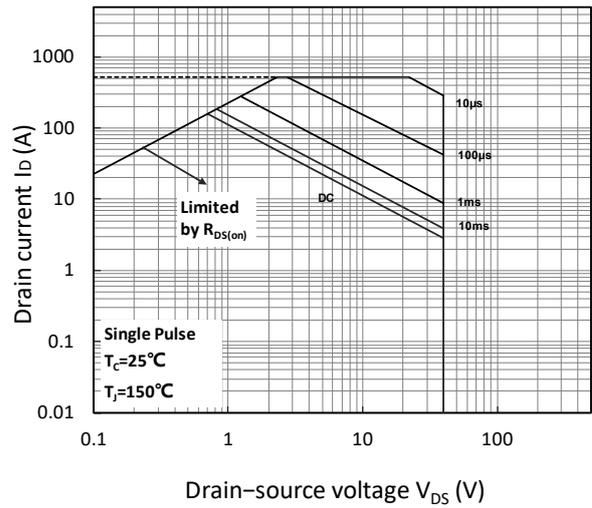


Figure 10. Safe Operating Area

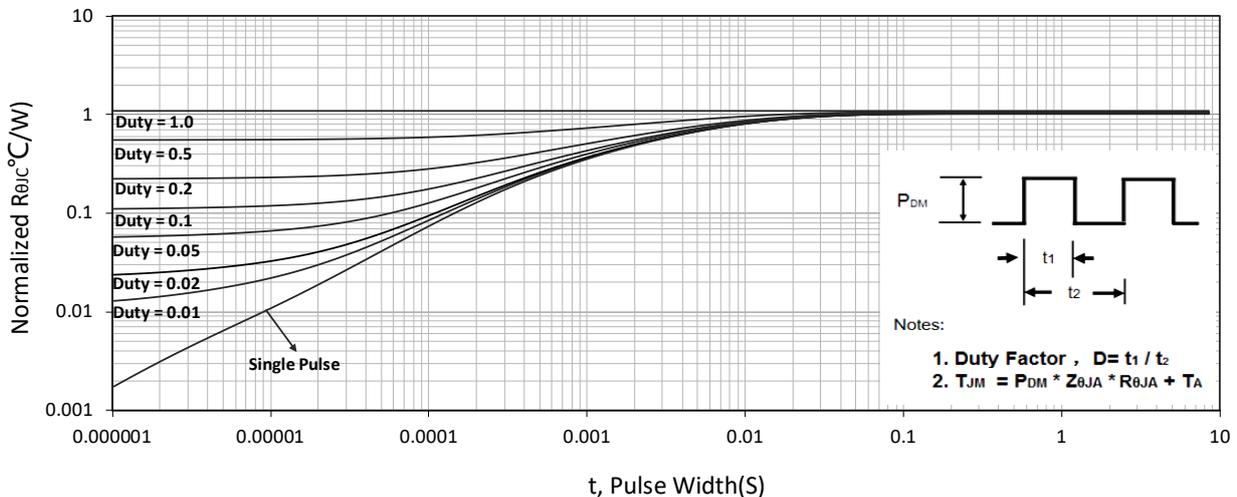


Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit

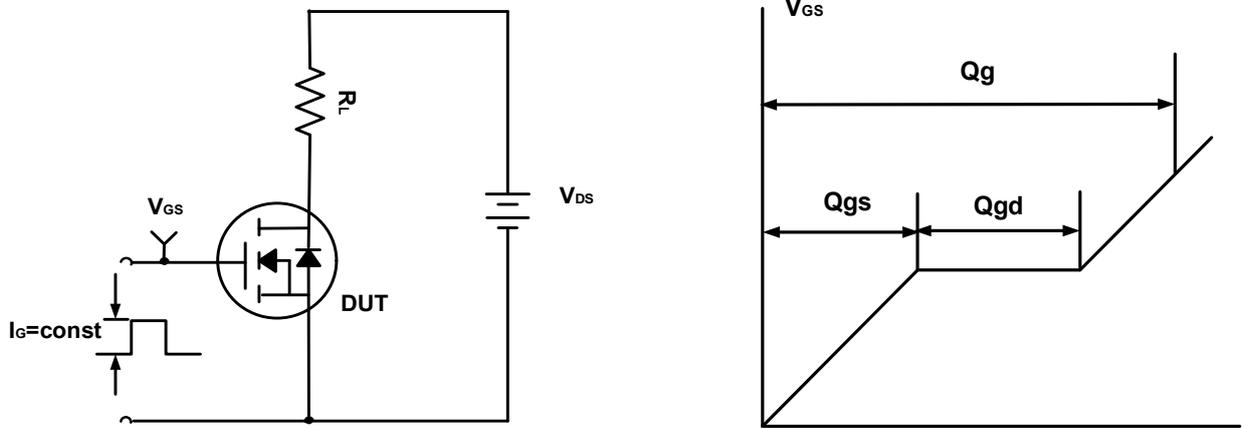


Figure A. Gate Charge Test Circuit & Waveforms

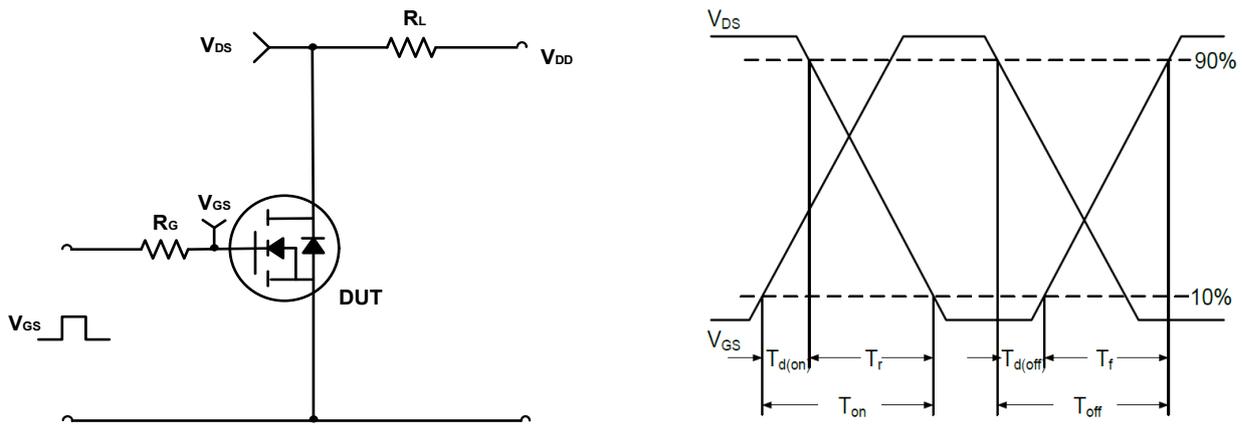


Figure B. Switching Test Circuit & Waveforms

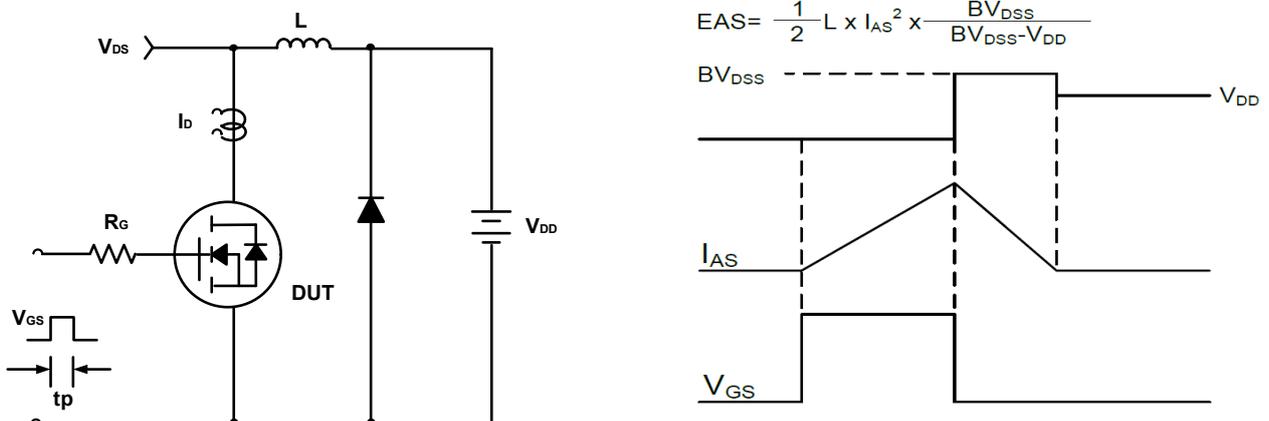
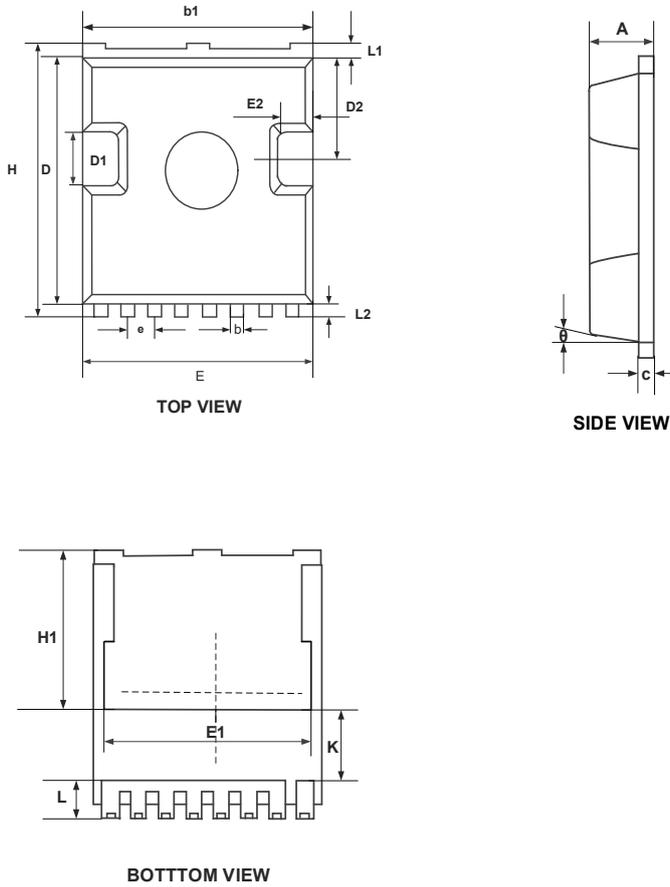


Figure C. Unclamped Inductive Switching Circuit & Waveforms

Mechanical Dimensions for TOLL



COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	2.20	2.40
b	0.60	0.90
b_1	9.70	9.90
c	0.40	0.60
D	10.20	10.60
D_1	3.10	3.50
D_2	4.45	4.75
E	9.70	10.10
E_1	7.80BSC	
E_2	0.50	0.70
e	1.200 BSC	
H	11.45	11.90
H_1	6.75 BSC	
K	3.10 REF	
L	1.70	2.10
L_1	0.60	0.80
L_2	0.50	0.70
θ	10° REF	